

**KEMET Part Number: C1812X473K1RACTU**  
(C1812X473K1RAC7800)

SMD Comm X7R Flex, Ceramic, 0.047 uF, 10%, 100 VDC, X7R, SMD, MLCC, FT-CAP, Temperature Stable, 1812



**Dimensions**

Dimensions	
Chip Size	1812
L	4.5mm +/-0.4mm
W	3.2mm +/-0.3mm
T	1mm +/-0.10mm
B	0.7mm +/-0.35mm

**Packaging Specifications**

<b>Packaging:</b>	T&R, 180mm, Plastic Tape
<b>Packaging Quantity:</b>	1000

**General Information**

<b>Series:</b>	SMD Comm X7R Flex
<b>Style:</b>	SMD Chip
<b>Description:</b>	SMD, MLCC, FT-CAP, Temperature Stable
<b>Features:</b>	FT-CAP, Temperature Stable
<b>RoHS:</b>	Yes
<b>Termination:</b>	Flexible Termination
<b>Marking:</b>	No
<b>AEC-Q200:</b>	No
<b>Component Weight:</b>	95 mg
<b>Shelf Life:</b>	78 Weeks
<b>MSL:</b>	1

**Specifications**

<b>Capacitance:</b>	0.047 uF
<b>Measurement Condition:</b>	1 kHz 1.0Vrms
<b>Capacitance Tolerance:</b>	10%
<b>Voltage DC:</b>	100 VDC
<b>Dielectric Withstanding Voltage:</b>	250 VDC
<b>Temperature Range:</b>	-55/+125°C
<b>Temperature Coefficient:</b>	X7R
<b>Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC):</b>	15%, 1kHz 1.0Vrms
<b>Dissipation Factor:</b>	2.5% 1 kHz 1.0Vrms
<b>Aging Rate:</b>	3% Loss/Decade Hour: Referee Time is 1000 Hours
<b>Insulation Resistance:</b>	21.2766 GOhms